

ABSTRACT

METHOD OF OBTAINING A YELLOW GOLD ALLOY
DEPOSITION BY GALVANOPLASTY WITHOUT USING TOXIC
METALS OR METALLOIDS

The invention relates to an electrolytic deposition in the form of a gold alloy with a thickness of between 1 and 800 microns and which includes copper. According to the invention, the deposition includes indium as the third main compound.

- 5 The invention concerns the field of electroplating methods.